

Technical Data Sheet

1.6mm Round Subminiature Reverse Package Chip LED

HIR26-21C/L423/TR8

Features

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Package in 8mm tape on 7" diameter reel.
- The product itself will remain within RoHS compliant version.



Descriptions

• HIR26-21C/L423/TR8 is an infrared emitting diode in miniature SMD package which is molded in a water clear plastic with spherical top view lens.

The device is spectrally matched with silicon photodiode and phototransistor

Applications

- PCB mounted infrared sensor
- Infrared remote control units with high power requirement
- Scanner
- Infrared applied system

Device Selection Guide

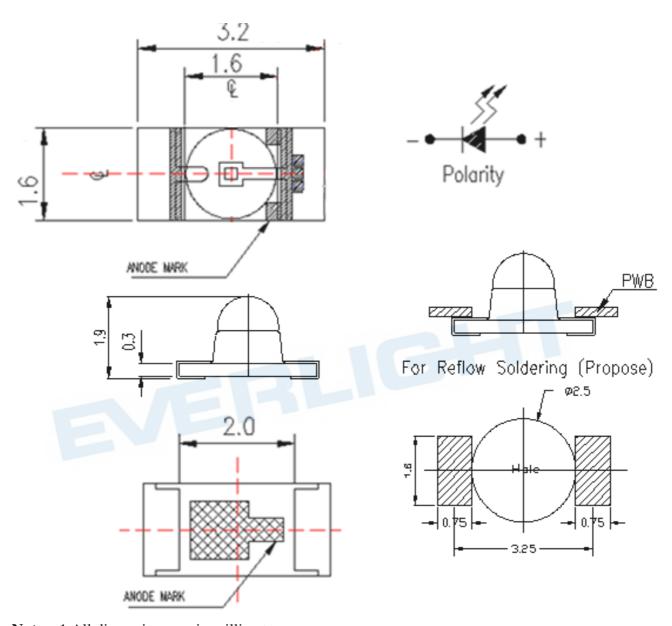
Part No.	Chip	Davin Calan	
	Material	Resin Color	
HIR	GaAlAs	Water clear	

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Prepared date: 26-Feb-2011 Prepared by:Shaoming Feng



Package Dimensions



Notes: 1.All dimensions are in millimeters 2.Tolerances unless dimensions ±0.1mm

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Absolute Maximum Ratings (Ta=25 $^{\circ}$ C)

Parameter	Symbol Rating		Units	
Continuous Forward Current	$ m I_F$	65	mA	
Reverse Voltage	V_R	5	V	
Operating Temperature	T_{opr}	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Storage Temperature	T_{stg}	-40 ~ +85	$^{\circ}\!\mathbb{C}$	
Soldering Temperature	T_{sol}	260	$^{\circ}\!\mathbb{C}$	
Power Dissipation at(or below)	P_d	110	mW	
25°C Free Air Temperature				

Electro-Optical Characteristics (Ta=25℃)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units	
Radiant Intensity	Ie	$I_F=20mA$	14.0 16.0			mW/sr	
Peak Wavelength	λр	$I_F=20mA$		850		nm	
Spectral Bandwidth	Δλ	I _F =20mA		42	1	nm	
Forward Voltage	V_{F}	I _F =20mA		1.45	1.70	V	
Reverse Current	I_R	$V_R=5V$	D		10	μ A	
Optical rise and fall time	t _r /t _f	I _F =50mA		25/15	35/35	ns	
View Angle	2 0 1/2	I _F =20mA		20		deg	

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Typical Electro-Optical Characteristics Curves

Fig.1 Forward Current vs.

Ambient Temperature

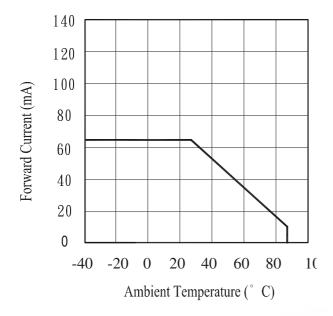


Fig.2 Spectral Distribution

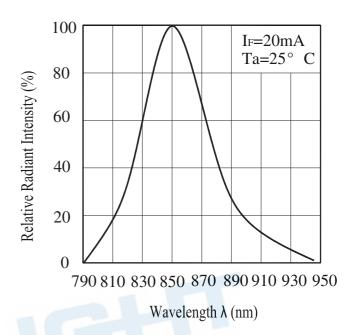


Fig.3 Peak Emission Wavelength
Ambient Temperature

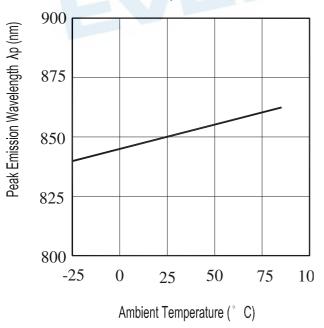
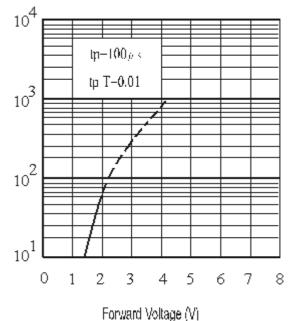


Fig.4 Forward Current vs. Forward Voltage



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orward Current IF (mA)



Typical Electro-Optical Characteristics Curves

Fig.5 Radiant Intensity vs. Angular Displacement

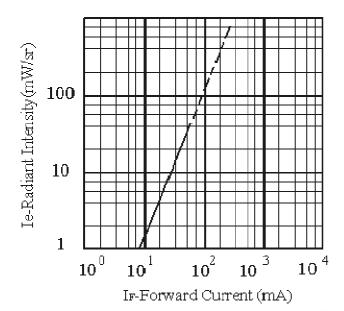
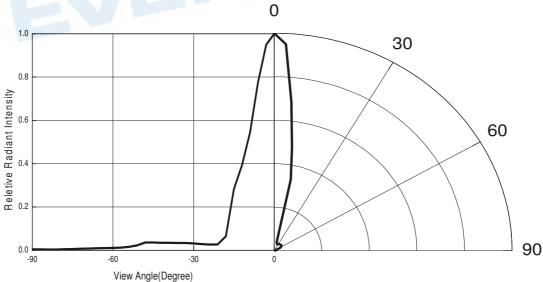


Fig.6 Relative Radiant Intensity vs.





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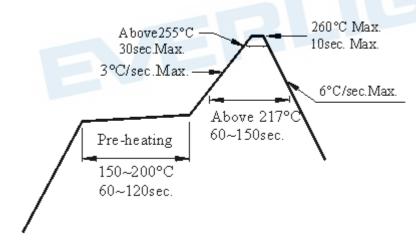
Precautions For Use

1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
 - 2.1 Do not open moisture proof bag before the products are ready to use.
 - 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
- 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

 Baking treatment: 60±5°C for 24 hours.
- 3. Soldering Condition
 - 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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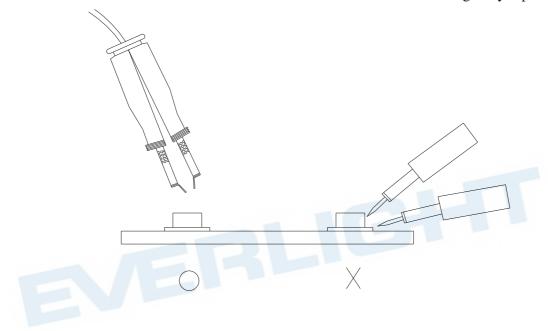


4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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Reliability Test Item And Condition

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

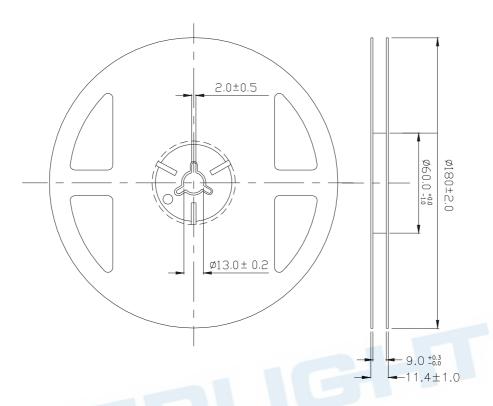
NO.	Item	Test Conditions	Test Hours/	Sample	Failure	Ac/Re
			Cycles	Sizes	Judgement	
					Criteria	
1	REFLOW Soldering	TEMP. : 260°C±5°C	6Mins	22pcs		0/1
		Max:10 secs			$I_R \ge U \times 2$	
2	Temperature Cycle	H:+100°C 15mins	300Cycles	22pcs	I≞≦Lx0.8	0/1
		5mins			$V_F \ge U \times 1.2$	
		L: -40°C 15mins				
3	Thermal Shock	H :+100°C ▲ 5mins	300Cycles	22pcs	U: Upper	0/1
		↓ 10secs			Specification	
		L:- 10° C 5mins			Limit	
4	High Temperature	TEMP. ∶ +100°C	1000hrs	22pcs	L: Lower	0/1
	Storage				Specification	
5	Low Temperature	TEMP. : -40°C	1000hrs	22pcs	Limit	0/1
	Storage					
6	DC Operating Life	$I_F=20$ mA/25 $^{\circ}$ C	1000hrs	22pcs		0/1
7	High Temperature/	85℃ / 85% R.H	1000hrs	22pcs		0/1
	High Humidity					

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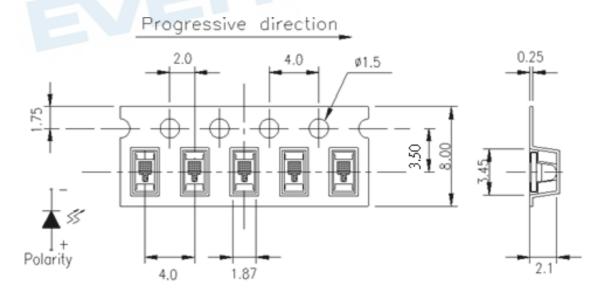
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Reel Dimensions



Carrier Tape Dimensions: Loaded quantity 1500 PCS per reel:



Note: The tolerances unless mentioned is ± 0.1 mm, Unit = mm

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Label Form Specification



CPN: Customer's Production Number

P/N: Production Number **QTY: Packing Quantity**

CAT: Ranks

HUE: Peak Wavelength

EF: Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

Notes

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

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